

REMARKS

Claims 4, 6, and 8 stand objected to under 37 C.F.R. 1.75(c) as being of improper dependent form for failing to further limit the subject matter of a previous claim. Specifically, the Examiner asserts that each of these claims replaces in the dependent claim a step recited in the independent claim. This assertion is erroneous. None of the claim language in any of these three claims recites the previous step is actually replaced. Claims 4, 6, and 8 respectively merely recite additional steps in the previously recited step, with no suggestion of removing any previously recited step.

Applicant submits that claims 4, 6, and 8 demonstrate a common, and acceptable, standard of patent claim drafting. Nevertheless, although Applicant submits that such is not necessary, in the interests of expediting prosecution, Applicant has added the word “further” to clarify for the Examiner that the steps he objects to in the cited claims are additional steps, and by no means replacement steps. Accordingly, because these amendments are merely grammatical in nature, and not directed toward the substance of the claims, Applicant submits that such amendments are appropriate for entry after final rejection.

Claims 3-8 and 12-13 stand rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement. Specifically, the Examiner asserts that the Specification to the present Application does not disclose embodiments which show a combination of all of the embodiments that the Specification does show. With respect to claims 4 and 8, Applicant respectfully traverses this rejection because claims 4 and 8 have

been rewritten in independent form, but without the subject matter from original claim 9. With respect to claims 3, 5-7, and 12-13, Applicant respectfully traverses because the Examiner has misapplied the written description requirements from Section 112.

The first paragraph of Section 112 does not require that the Specification illustrate every possible iteration and permutation of the novel features described by that invention, as the Examiner appears to imply. Instead, the first paragraph of Section 112 only requires that the Specification contain a written description of the invention “in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains...to make and use the same.” (Emphasis added). Applicant submits that the present Specification fulfills this requirement.

Regarding claim 3 specifically, there is no conflict between the subject matter of claim 3, which addresses different size panels being formed in the same block, and the subject matter of the fifth embodiment, which addresses the formation of a semiconductor film above the sub-TFT substrate. One skilled in the art would be clearly aware from the description in the present Specification how to form different size panels in the same block, irrespective of the teachings regarding the semiconductor film described in the fifth embodiment. In fact, the description of the fifth embodiment of the present invention expressly discloses how a multitude of different types of liquid crystal panels may be formed in conjunction with that embodiment. (See page 51, line 13 to page 52, line 3).

One skilled in the art would be further apprised that all of the described different types of panels could also be of differing sizes, according to the methods fully described elsewhere in the Specification. Most importantly, there is no description in the fifth embodiment that the formation of different size panels in the same block would be excluded. Accordingly, for at least these reasons, the Section 112 rejection of claim 3 is respectfully traversed.

With respect to claim 5 specifically, Applicant submits that the present Specification clearly satisfies the Section 112 requirements. Claim 5 addresses subject matter related to the recited arraying step. The arraying step is recited to be before the formation of the TFT. The fifth embodiment of the present invention, on the other hand, describes that the unique features of that embodiment occur after the formation of the TFT. (See page 48, lines 10-12). The Examiner has made no showing of how one skilled in the art would not know how to perform the arraying features recited in claim 5, together with the semiconductor features described in the fifth embodiment. As described above, the fifth embodiment specifically teaches that many different kinds of panels may be formed according to that embodiment. Accordingly, for at least these reasons, the rejection of claim 5 is respectfully traversed.

The Examiner's rejection of claim 6 is respectfully traversed for similar reasons to those discussed above. Nothing in the description of the fifth embodiment excludes the combination of the semiconductor film with the featured corner cutting and end face

processing of claim 6. Again, the Examiner has made no showing that one skilled in the art would not know how to perform all of these features in the same device, where all of the features are all clearly described within the present Specification. Accordingly, the rejection of claim 6 is also traversed.

With respect to claim 7 specifically, Applicant respectfully traverses the rejection for reasons similar to those discussed above with respect to claim 5. The block plotting features recited in claim 7 are also performed prior to TFT formation. The description in the fifth embodiment clearly teaches that the method may be the same as other embodiments up to the formation of the TFT. Accordingly, the rejection of claim 7 is also traversed.

With respect to claims 12 and 13 specifically, Applicant respectfully traverses this rejection for reasons similar to those discussed above in traversing the rejection of claim 3. Whereas claim 3 described different sizes of panels being formed in the same block, claims 12 and 13 each recite that different types of panels may be formed. And, as discussed above, the description in the fifth embodiment of the present invention clearly explains how many different types of panels may be formed according to the fifth embodiment. One skilled in the art, therefore, would clearly understand from this teaching in the fifth embodiment that different types of panels could be formed according to the clear description elsewhere in the specification. The Examiner has made no showing how one could exclude

the other. Accordingly, for at least these reasons, the rejection of claims 12 and 13 is also respectfully traversed.

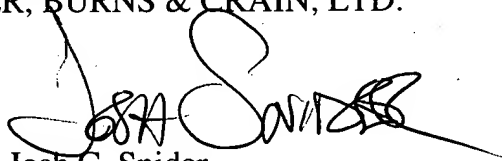
With respect to the remaining claims, Applicant has amended claims 11-14 to correct for the grammatical and/or typographical errors noted by the Examiner, and according to the suggestions made by the Examiner in the outstanding Office Action. Claim 7 has also been amended to correct for grammatical and/or typographical errors. Accordingly, Applicant submits that all of the amendments contained herein are appropriate for entry after final rejection.

For all of the foregoing reasons, Applicant submits that this Application, including claims 1-8 and 10-14, is condition for allowance, which is respectfully requested. The Examiner is invited to contact the undersigned attorney if an interview would expedite prosecution.

Respectfully submitted,

GREER, BURNS & CRAIN, LTD.

By



Josh C. Snider

Registration No. 47,954

Customer No. 24978

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300 South Wacker Drive - Suite 2500

Chicago, Illinois 60606

Tel: (312) 360-0080

Fax: (312) 360-9315

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